Tender of

RMB-denominated 2.44 per cent. Bonds due 2024 (the "Additional 2024 Bonds") (to be consolidated and form a single series with the RMB6.5 billion 2.44 per cent. Bonds due 2024 (the "Original 2024 Bonds"))

and

RMB-denominated 2.75 per cent. Bonds due 2027 (the "Additional 2027 Bonds") (to be consolidated and form a single series with the RMB2.5 billion 2.75 per cent. Bonds due 2027 (the "Original 2027 Bonds"))

To be held on 12 October 2022

The Ministry of Finance of the People's Republic of China (the "Ministry of Finance") announces that a tender of the Additional 2024 Bonds and the Additional 2027 Bonds (together, the "Additional Bonds") of the Central People's Government will be held on Wednesday, 12 October 2022, for settlement on Friday, 14 October 2022.

A total of RMB3.5 billion Additional 2024 Bonds and RMB2.0 billion Additional 2027 Bonds will be made available for competitive tender on a price-bid basis by any qualified Central Moneymarkets Unit ("CMU") members through the CMU BID. Upon issuance, the Additional 2024 Bonds will be consolidated and form a single series with the Original 2024 Bonds (the "2024 Bonds") and the Additional 2027 Bonds will be consolidated and form a single series with the Original 2027 Bonds (the "2027 Bonds", together with the 2024 Bonds, the "Bonds"). The 2024 Bonds bear interest at 2.44 per cent. per annum. The 2027 Bonds bear interest at 2.75 per cent. per annum. The 2024 Bonds and the 2027 Bonds will mature in 2024 and 2027, respectively, on the last interest payment date of the relevant series of Bonds. Each series of Additional Bonds will be issued at the uniform issue price i.e. the lowest accepted price of the successful competitive tender bids for the relevant series, plus accrued interest.

Each tender must be for an amount of RMB500,000 or integral multiples thereof and the difference between any specified tender price should be at least 0.01%, rounded to two decimal places.

The tender results will be published on the website of the Hong Kong Monetary Authority ("HKMA") (https://www.hkma.gov.hk) and the CMU Website (https://www.cmu.org.hk).

The Tender Information Memorandum of the Ministry of Finance dated 6 October 2022 includes the details of the tender of the Additional Bonds, including the terms of the Bonds, the tender arrangements and the application, payment and settlement procedures. Copies of the Tender Information Memorandum can be obtained from the HKMA at 55/F, Two International Finance Centre, 8 Finance Street, Central, Hong Kong (Tel: 8100 0136) or from the Issuing and Lodging Agent, Bank of Communications Co., Ltd, Hong Kong Branch at 20 Pedder Street, Central, Hong Kong (Tel: 2315 7386 / 2315 7387). It can also be downloaded from the respective websites of the HKMA and the Issuing and Lodging Agent at https://www.bankcomm.com.hk.

The Ministry of Finance will tender the Additional Bonds through the CMU BID. The tender and settlement of the Additional Bonds will be governed by the Tender Information Memorandum and the Applicable Terms and Conditions of CMU BID issued by the HKMA as the system administrator and service provider of the CMU BID, as amended from time to time, the CMU Operating Procedures and other relevant CMU rules (subject to any amendments under the Tender Information Memorandum).

The Ministry of Finance has appointed Bank of Communications Co., Ltd. Hong Kong Branch as the Issuing and Lodging Agent to administer the tender of the Additional Bonds on its behalf.

The Ministry of Finance of the People's Republic of China 6 October 2022

Bonds Tender Information

Information of each series of Additional Bonds:

CMU Instrument No. : 2024 Bonds: BCMKFB22009

2027 Bonds: BCMKFB22011

Tender Date and Time : Wednesday, 12 October 2022

9:30 a.m. to 10:30 a.m.

Issue and Settlement Date : Friday, 14 October 2022

Aggregate Principal Amount

Tendered : Additional 2024 Bonds: RMB3.5 billion

Additional 2027 Bonds: RMB2.0 billion

Denomination : RMB500,000 each

Issue Price : Each series of Additional Bonds will be issued at the lowest

accepted price of the successful competitive tender bids for the

relevant series, plus accrued interest

Maturity Date : Last interest payment date of the relevant series of Bonds in 2024

and 2027 respectively

Interest Rates and Accrued

Interest

The 2024 Bonds bear interest at 2.44 per cent. per annum and the accrued interest on each 2024 Bond from and including 17 June 2022 up to but excluding the Further Issue Date is RMB3,977.53

The 2027 Bonds bear interest at 2.75 per cent. per annum and the accrued interest on each 2027 Bond from and including 17 June 2022 up to but excluding the Further Issue Date is RMB4,482.88

Interest Payment Dates : In respect of the 2024 Bonds and the 2027 Bonds: 17 June and 17

December in each year, subject to the modified following business

day convention

Tender Amount . RMB500,000 or integral multiples thereof and the difference

between any specified tender prices should be at least 0.01%,

rounded to two decimal places

Other details : Please refer to the Tender Information Memorandum

The Ministry of Finance of the People's Republic of China

6 October 2022

Note: This Tender Notice is published in Chinese and English. The English version is intended for ease of reference only. In the event of any inconsistency between the Chinese version and English version of this Tender Notice, the Chinese version shall prevail.